

Features

Ultra-Low capacitance:0.05pF(typ.)

Low leakage current(<10nA)

Fast response time(<1ns)

Bi-directional,single line protection

IEC 61000-4-2 (ESD Air): 15kV

IEC 61000-4-2 (ESD Contact): 8kV

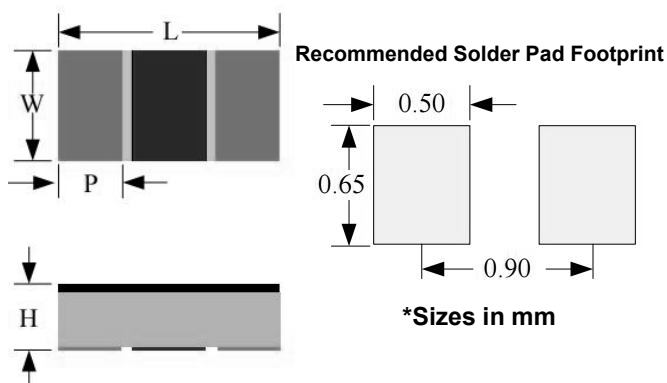
Applications

USB 3.0/3.1

HDMI 1.3/1.4/2.0

RF Antenna

SATA and eSATA Interface



Notes:

This solder pad layout is for reference purposes only.

Dimension	Unit: Millimeters	
	Min.	Max.
L	0.90	1.10
W	0.42	0.62
p	0.15	0.35
H	0.25	0.45

Absolute Maximum Rating

Symbol	Parameter	Conditions	Min	Max	Unit
V _{ESD}	Electrostatic Discharge Voltage	IEC 61000-4-2; Contact Discharge	-	8	kV
		IEC 61000-4-2; Air Discharge	-	15	kV
T _A	Operating Temperature Range	-	-55	125	°C
T _{stg}	Storage Temperature Range	-	-40	85	°C

LXES15AAA1-153

Electrical Characteristics ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ.	Max	Unit
V_{DC}	Continuous Operating Voltage	-	-	-	5.0	V
V_T	Trigger Voltage	IEC61000-4-2 8kV contact discharge	-	450	-	V
V_C	Clamping Voltage	IEC61000-4-2 8kV contact discharge	-	40	-	V
I_L	Leakage Current	DC 5V shall be applied on component	-	-	10	nA
C_J	Capacitance	Measured at 10MHz	-	0.05	-	pF

RATING AND CHARACTERISTIC CURVES (LXES15AAA1-153)

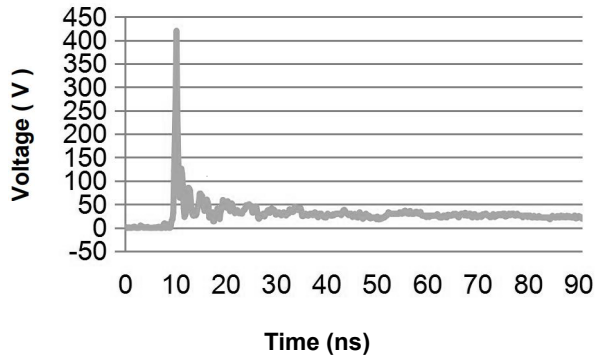


Fig.1 Typical ESD Response
(IEC 61000-4-2, 8kV contact discharge)

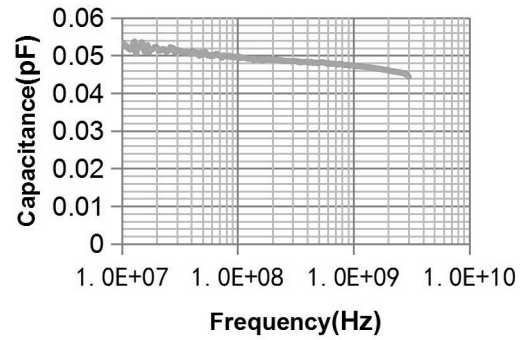


Fig.2 Typical Device Capacitance VS. Frequency